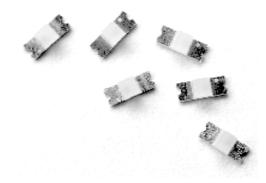
HSMx-C265 Surface Mount Chip LEDs







Description

The HSMx-C265 is a reverse mountable chip-type LED for lighting the non-component side of a PCB board. In this reverse mounting configuration, this LED is designed to emit light through a small cut-out hole in the PC board.

The HSMx-C265 is available in four colors. The small size, narrow footprint, and low profile make this series of LEDs excellent for backlighting, status indication, and front panel illumination application.

Features

- Reverse mountable
- Undiffused optics
- Small 3.4 x 1.25 mm footprint
- Operating temperature range of -30°C to +85°C
- Compatible with IR solder reflow
- Four colors available: red, orange, yellow, and green
- Available in 8 mm tape on 7" (178 mm) diameter reels

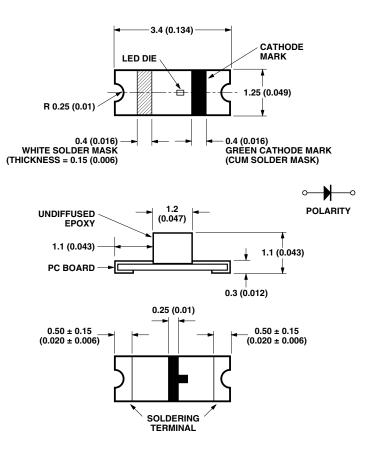
Applications

- Keypad backlighting
- Symbol backlighting
- LCD backlighting
- Status indication

| Part Number | Color | Parts Per Reel 3000 | |
|-------------|---------------------|------------------------|--|
| HSMS-C265 | High Efficiency Red | | |
| HSMD-C265 | Orange | 3000 | |
| HSMY-C265 | Yellow | 3000 | |
| HSMG-C265 | Green | 3000 | |
| HSMH-C265 | AlGaAs Red | 3000 | |

Device Selection Guide

Package Dimensions



Notes:

1. All dimensions in millimeters (inches).

2. Tolerance is \pm 0.1 mm (\pm 0.004 in.) unless otherwise specified.

3. Polarity of HSMH-C265 will be the opposite of what is shown on above drawing.

Absolute Maximum Ratings

 $T_A = 25^{\circ}C$

| Parameter | HSMD/G/S/Y-C265 | HSMH-C265 | Units |
|---------------------------------------|----------------------|-----------------|-------|
| DC Forward Current ^[1] | 25 | 25 | mA |
| Peak Pulsing Current ^[2] | 100 | 100 | mA |
| Power Dissipation | 65 | 65 | mW |
| Reverse Voltage ($I_R = 100 \mu A$) | 5 | 5 | V |
| Led Junction Temperature | 95 | 95 | °C |
| Operating Temperature Range | -30 to +85 | -30 to +85 | °C |
| Storage Temperature Range | -40 to +85 | -40 to +85 | °C |
| Soldering Temperature | See IR soldering pro | file (Figure 6) | |

Notes:

1. Derate linearly as shown in Figure 4.

2. Pulse condition of 1/10 duty and 0.1 msec. width.

Electrical Characteristics

$T_A = 25^{\circ}C$

| | Forward Voltage V _F (Volts) @ I _F = 20 mA | | Reverse Breakdown V _R (Volts) @ I _R = 100 μA | Capacitance C (pF), V _F = 0, f = 1 MHz | Thermal Resistance Rθ _{J-PIN} (°C/W) |
|-------------|---|------|--|---|---|
| Part Number | Тур. | Max. | Min. | Typ. ^[1] | Тур. |
| HSMS-C265 | 2.1 | 2.6 | 5 | 8 | 250 |
| HSMD-C265 | 2.2 | 2.6 | 5 | 6 | 250 |
| HSMY-C265 | 2.1 | 2.6 | 5 | 7 | 250 |
| HSMG-C265 | 2.2 | 2.6 | 5 | 6 | 250 |
| HSMH-C265 | 1.8 | 2.6 | 5 | 18 | 300 |

Optical Characteristics

| $T_{\Lambda} = 2$ | 5°C |
|-------------------|-----|
|-------------------|-----|

| | | Luminous Intensity I _v (mcd) @ 20 mA ^[1] | | Peak Wavelength λ _{peak} (nm) | Dominant Wavelength λ _d (nm) ^[2] | Viewing Angle 2θ _{1/2} Degrees ^[3] |
|-------------|--------|---|------|---|---|---|
| Part Number | Color | Min. | Тур. | Тур. | Typ. | Typ. |
| HSMS-C265 | HER | 2.5 | 10.0 | 630 | 626 | 150 |
| HSMD-C265 | Orange | 2.5 | 8.0 | 605 | 604 | 150 |
| HSMY-C265 | Yellow | 2.5 | 8.0 | 589 | 586 | 150 |
| HSMG-C265 | Green | 4.0 | 15.0 | 570 | 572 | 150 |
| HSMH-C265 | AlGaAs | 6.3 | 17.0 | 660 | 639 | 150 |

Notes:

1. The luminous intensity, I_v, is measured at the peak of the spatial radiation pattern which may not be aligned with the mechanical axis of the lamp package.

2. The dominant wavelength, λ_d , is derived from the CIE Chromatically Diagram and represent the perceived color of the device.

3. $\theta_{1/2}$ is the off-axis angle where the luminous intensity is 1/2 the peak intensity.

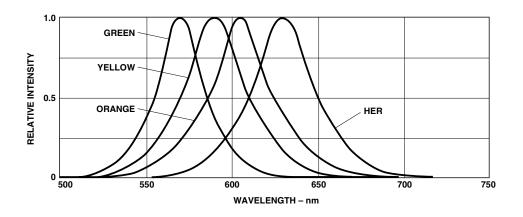


Figure 1. Relative intensity vs. wavelength.

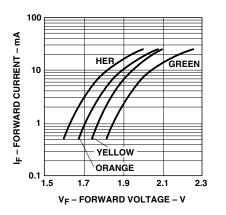


Figure 2. Forward current vs. forward

voltage.

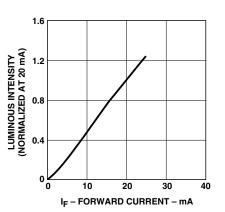


Figure 3. Luminous intensity vs. forward current.

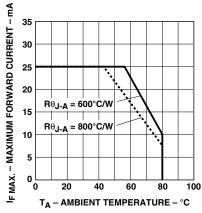


Figure 4. Maximum forward current vs. ambient temperature.

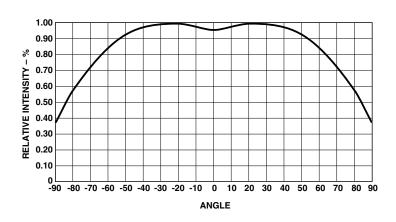
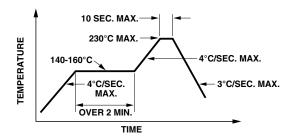


Figure 5. Relative intensity vs. angle.





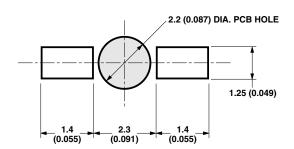


Figure 7. Recommended soldering pad pattern.

Note: 1. All dimensions in millimeters (inches).

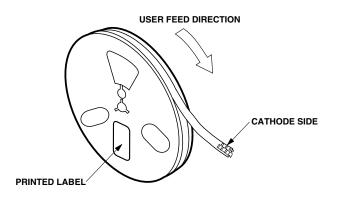


Figure 8. Reeling orientation.

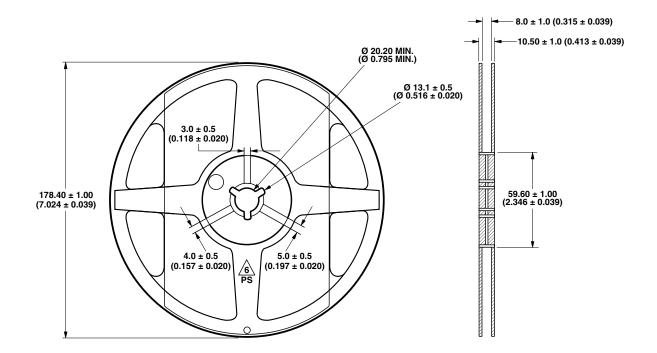


Figure 9. Reel Dimensions.

Note: 1. All dimensions in millimeters (inches).

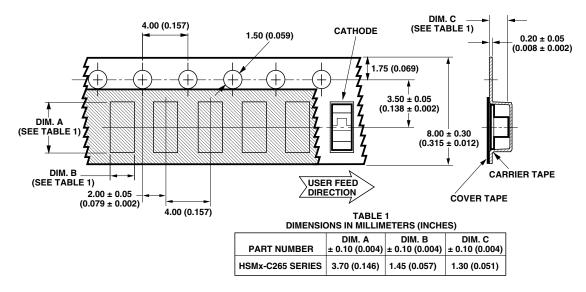


Figure 10. Tape dimensions.

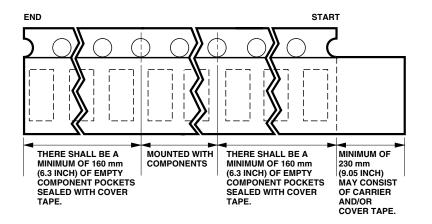


Figure 11. Tape leader and trailer dimensions.

Notes:

1. All dimensions in millimeters (inches).

2. Tolerance is \pm 0.1 mm (\pm 0.004 in.) unless otherwise specified.

Storage Condition: 5 to 30°C at 60% RH max. Baking is required under the condition: a) the blue silica gell indicator becoming white/transparent color b) the pack has been open for more than 1 week

Baking recommended condition: $60 \pm 5^{\circ}$ C for 20 hours.

Convective IR Reflow Soldering For more information on IR reflow soldering, refer to Application Note 1060, Surface Mounting SMT LED Indicator Components.

For product information and a complete list of distributors, please go to our website: www.avagotech.com

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